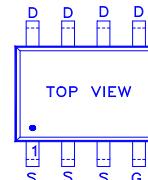
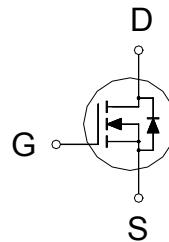


NIKO-SEM
**N-Channel Enhancement Mode
Field Effect Transistor**
P5515BV
SOP-8
Halogen-Free & Lead-Free
PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
150V	55mΩ	3.4A


G: GATE
D: DRAIN
S: SOURCE
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	150	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	3.4	A
	$T_A = 70^\circ\text{C}$		2.7	
Pulsed Drain Current ¹		I_{DM}	40	A
Avalanche Current		I_{AS}	16	
Avalanche Energy	$L = 1\text{mH}$	E_{AS}	128	mJ
Power Dissipation	$T_A = 25^\circ\text{C}$	P_D	1.5	W
	$T_A = 70^\circ\text{C}$		1	
Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$R_{\theta JA}$		80	°C / W

¹Pulse width limited by maximum junction temperature.²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.**ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	150			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.3	1.75	2.3	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 120\text{V}, V_{GS} = 0\text{V}$			1	μA
		$V_{DS} = 100\text{V}, V_{GS} = 0\text{V}, T_J = 125^\circ\text{C}$			10	
Drain-Source On-State Resistance ¹	$R_{DS(\text{ON})}$	$V_{GS} = 4.5\text{V}, I_D = 3\text{A}$		44.5	65	$\text{m}\Omega$
		$V_{GS} = 10\text{V}, I_D = 3\text{A}$		43	55	

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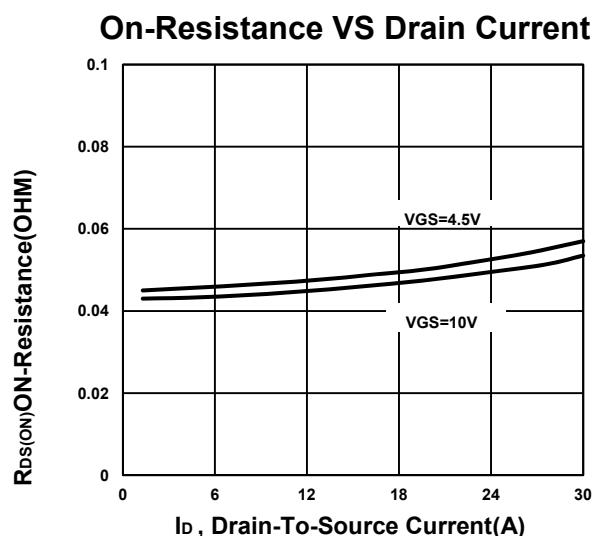
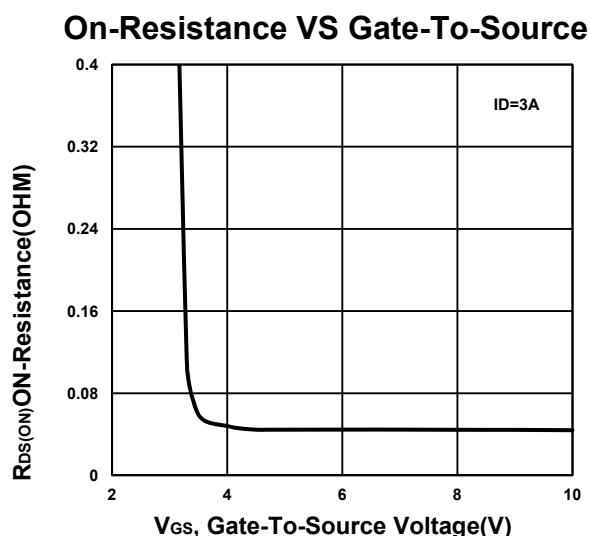
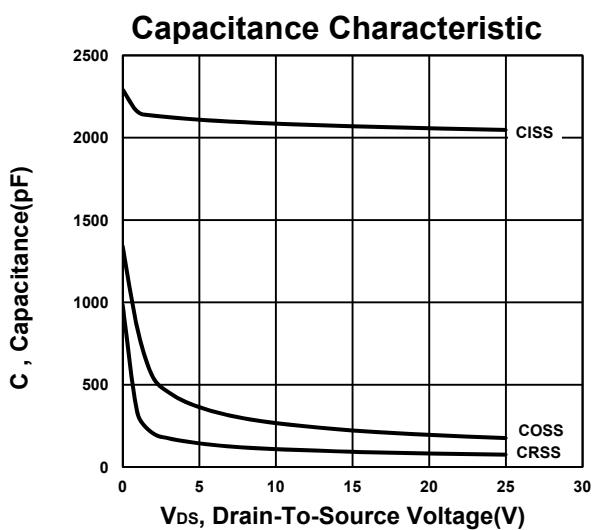
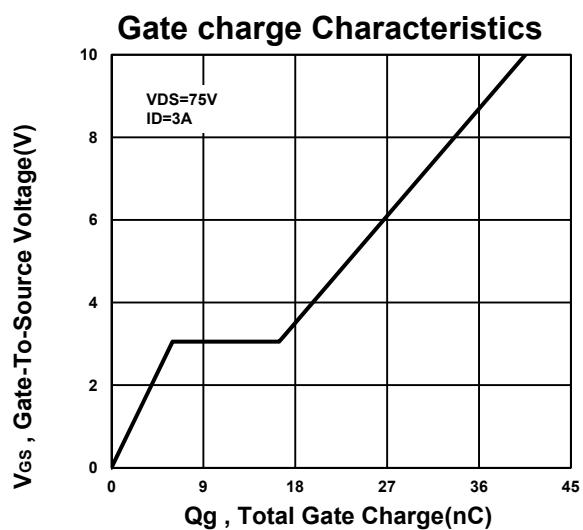
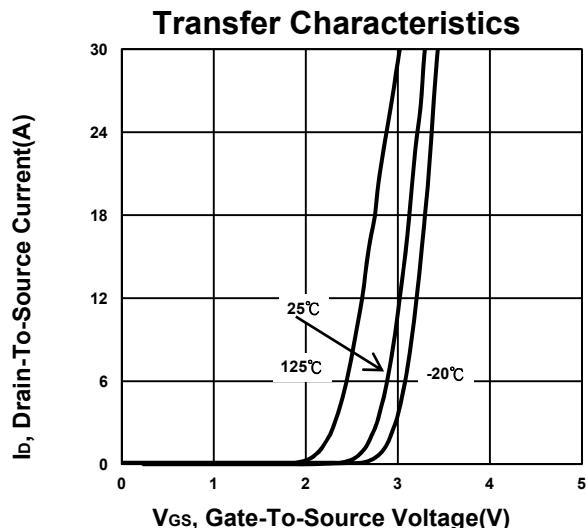
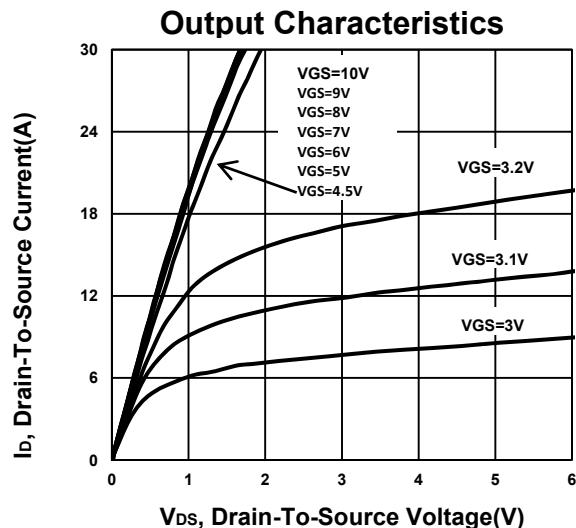
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 3A$		25		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		2042		pF
Output Capacitance	C_{oss}			176		
Reverse Transfer Capacitance	C_{rss}			75		
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$		1		
Total Gate Charge ²	Q_g	$V_{DS} = 75V, V_{GS} = 10V, I_D = 3A$		40		nC
Gate-Source Charge ²	Q_{gs}			6		
Gate-Drain Charge ²	Q_{gd}			10		
Turn-On Delay Time ²	$t_{d(on)}$			17		
Rise Time ²	t_r	$V_{DS} = 75V, I_D \geq 3A, V_{GS} = 10V, R_{GEN} = 6\Omega$		18		nS
Turn-Off Delay Time ²	$t_{d(off)}$			68		
Fall Time ²	t_f			45		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)						
Continuous Current	I_S				1.5	A
Forward Voltage ¹	V_{SD}	$I_F = 3A, V_{GS} = 0V$			1	V
Diode Reverse Recovery Time	t_{rr}	$I_F = 3A, dI/dt=100A/\mu s$		60		nS
Diode Reverse Recovery Charge	Q_{rr}			111		nC

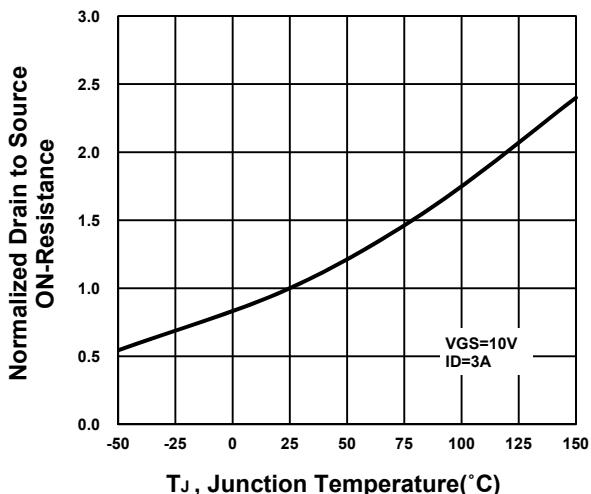
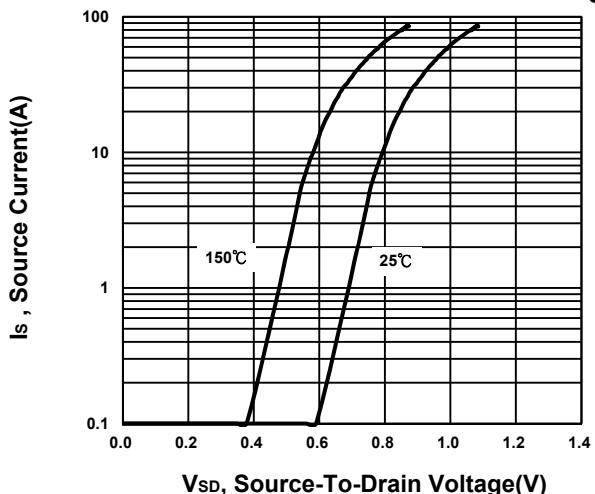
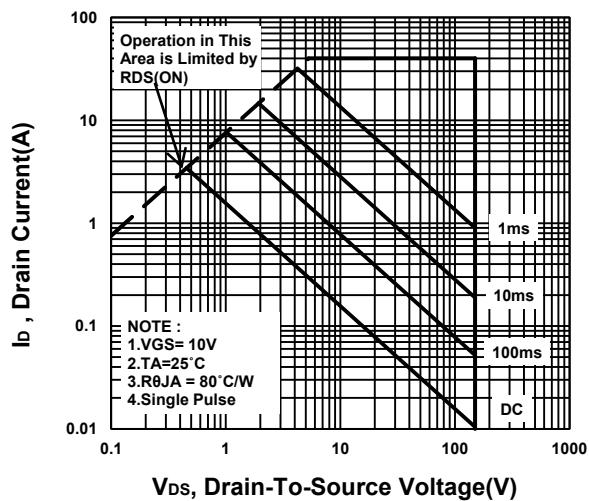
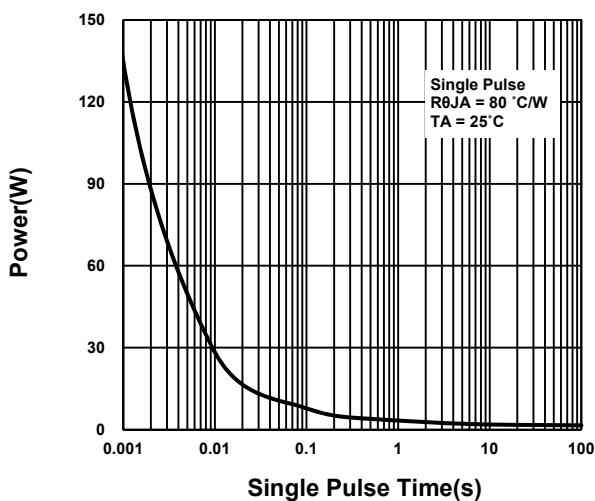
¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.²Independent of operating temperature.

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On-Resistance VS Temperature**Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**